APPLICA	BLE STAN	DARD								
Operating			55.0	~~		rage		10.00 / 00		
	Temperature Range		-55 °C to 105 °C (1)		Ter	Геmperature Range		-10 °C to 60	°C (2)	
RATING	Voltage		600 V AC/D	С	Sto	rage Hu	midity Range	40 % to 70	% ⁽²⁾	
	Current		13A		Оря	Operating Humidity Range				
			SPECIFICATION			<u></u>		(Not dewed)		
					ATION	5				1
	EM	TEST METHOD				REQL	JIREMENTS	QT	AT	
CONSTRU		1								
	General Examination Marking		Visually and by measuring instrument. Confirmed visually.				ing to drawin	g.	×	×
ELECTRIC CHARAC		•							×	×
Contact Resistance		10 mA(DC or 1000Hz)				2 m Ω N	1 A Y		T ×	т_
Insulation Resistance		1000 V DC.				1000 M Ω MIN.				+ =
Voltage Proof		1800 V AC for 1 min.				No flashover or breakdown.			×	+-
MECHANICAL CHAR										1
Insertion and		Measured by applicable connector.				Insertion Force: 15 N MAX.				T —
Withdrawal Forces						Withdrawal Force: 0.6 N MIN.				
Mechanical Operation		100 times insertions and extractions.				① Contact Resistance: 5 m Ω MAX.				-
Vibration		Francisco 10 to 55 to 10 lb consess Frain				② No damage, crack and looseness of parts.				
Vibration		Frequency 10 to 55 to 10Hz, approx 5min Single amplitude: 0.75 mm, 10 cycles for 3 axial directions.				 No electrical discontinuity of 1 μs. No damage, crack and looseness of parts. 				
Shock		490 m/s ² , duration of pulse 11 ms, 3 times to both directions in 3 axial directions.								-
ENVIRON	MENTAL C	HARAC	TERISTICS							•
Damp Heat (Steady State	e)	Exposed at 40±2 °C, 90 ~ 95 %, 96 ±4h.				(1) Contact Resistance: $5m\Omega$ MAX. (2) Insulation Resistance: $1000 \text{ M}\Omega$ MIN.			×	<u> </u>
Rapid Change of		Temperature -55 → +105 °C				③ No damage, crack and looseness of parts.				_
Temperature		Time 30 → 30 min. under 5 cycles. (Relocation time to chamber: within 2~3 MIN)								
Dry heat		Exposed at +105±2°C for 96±4h.							×	_
Cold		Exposed at -55±2°C for 96±4h.				-				+-
Sulfur Dioxide		Exposed at 25±2°C, 75±5%RH,			① Contact Resistance: 5mΩ MAX.				<u> </u>	
		25 PPM for 96h±4h.				② No defect such as corrosion which impairs the function of connector.			×	
Resistance to		Solder bath : Solder temperature 260±5°C			No deformation of case of excessive looseness				_	
Soldering Heat		for immersion, duration 10±1sec.				of the t	erminal.			
		Soldering	irons: 380°C MAX. for 10 s	ec.						
Solderability		Soldered at solder temperature 240±3°C for immersion, duration 3 sec.				A new uniform coating of solder shall cover a minimum of 95 % of the surface being immersed.			d. ×	_
COUN	T P	ESCRIPTI	ON OF REVISIONS		DESIG	NED		CHECKED		TE
<u> </u>	+	11							+ -	
\sim	(1) Include temper	ature rise caused by current-carrying. s a long-term storage state product before assembly to PCB.				APPROVED HS. OKAWA			14 0	9. 12
	⁽²⁾ "Storage" mear					CHECKED KN. SHIBUYA DESIGNED DK. AIMOTO			14. 09. 11	
	for the unused									
									14. 09. 11	
Unless oth	erwise spec	ified, refe	fied, refer to JIS-C-5402,IEC60512.				DRAWN	DK. AIMOTO		
Note QT:Qu	ualification Tes ⊤	st AT:Ass	urance Test X:Applicable Test		DF	PRAWING NO.		ELC4-359167-00		
HS.			CATION SHEET		PART NO.		FX30B-3S-7. 62DS			
	HIF	HIROSE ELECTRIC CO., LTD.			CODE NO.		CL57	CL570-3605-0-00		



